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Journal Name:	Journal of Engineering Research and Reports
Manuscript Number:	Ms_JERR_51011
Title of the Manuscript:	Estimation of Solder Ball Collapse Height in Semiconductor Packaging using Theoretical and Solid Modeling Techniques
Type of the Article	

General guideline for Peer Review process:

This journal's peer review policy states that **NO** manuscript should be rejected only on the basis of '**lack of Novelty**', provided the manuscript is scientifically robust and technically sound. To know the complete guideline for Peer Review process, reviewers are requested to visit this link:

(<http://www.sciencedomain.org/page.php?id=sdi-general-editorial-policy#Peer-Review-Guideline>)



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PART 1: Review Comments

	Reviewer's comment	Author's comment (if agreed with reviewer, correct the manuscript and highlight that part in the manuscript. It is mandatory that authors should write his/her
Compulsory REVISION comments		
Minor REVISION comments		
Optional/General comments	<p>Reviewer's comment: Dear Editor: The manuscript focused on the "Estimation of Solder Ball Collapse Height in Semiconductor Packaging using Theoretical and Solid Modeling Techniques", which is new novel and very useful in material fields. It is recommended to accept after major revision. However, some parts need to revise, which are listed below as follows. The main points need to revise before publication.</p> <p>[1] The new relate references are needed to add in the revised manuscript. [2] The authors investigate many parameters in this study. What is optimal condition in this work? Please explain and add it in the revised manuscript. [3] The grammar of English should be written more carefully in the manuscript; English must be checked and improved by Native English speaker. [4] What are the important applications in this study? Please add in the revised manuscript. [5] Theoretical calculations how to set the initial conditions or parameters to get close to the actual situation. [6] Can theoretical calculations and practical applications be compared to each other? [7] What are the important applications in this study? Please add in the revised manuscript. [8] The authors investigate many parameters in this study. What is optimal condition in this work? Please explain and add it in the revised manuscript.</p>	

PART 2:

	Reviewer's comment	Author's comment (if agreed with reviewer, correct the manuscript and highlight that part in the manuscript. It is mandatory that authors should write his/her feedback here)
Are there ethical issues in this manuscript?	<i>(If yes, Kindly please write down the ethical issues here in details)</i>	

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